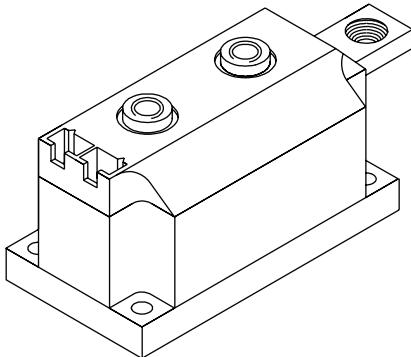


SCR/SCR and SCR/Diode (MAGN-A-PAK™ Power Modules), 170/250 A


MAGN-A-PAK™

FEATURES

- High voltage
- Electrically isolated base plate
- 3500 V_{RMS} isolating voltage
- Industrial standard package
- Simplified mechanical designs, rapid assembly
- High surge capability
- Large creepage distances
- Lead (Pb)-free
- Designed and qualified for industrial level


RoHS
COMPLIANT

DESCRIPTION

This new VSK series of MAGN-A-PAK™ modules uses high voltage power thyristor/thyristor and thyristor/diode in seven basic configurations. The semiconductors are electrically isolated from the metal base, allowing common heatsinks and compact assemblies to be built. They can be interconnected to form single phase or three phase bridges or as AC-switches when modules are connected in anti-parallel mode. These modules are intended for general purpose applications such as battery chargers, welders, motor drives, UPS, etc.

PRODUCT SUMMARY

I _{T(AV)}	170/250 A
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MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VSK.170..	VSK.250..	UNITS
I _{T(AV)}	85 °C	170	250	A
I _{T(RMS)}		377	555	
I _{TSM}	50 Hz	5100	8500	
	60 Hz	5350	8900	
I ² t	50 Hz	131	361	
	60 Hz	119	330	
I ² /t		1310	3610	kA ² s
V _{DRM/V_RRM}		Up to 1600		V
T _J	Range	- 40 to 130		°C

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS				
TYPE NUMBER	VOLTAGE CODE	V _{RRM/V_DRM} , MAXIMUM REPETITIVE PEAK REVERSE AND OFF-STATE BLOCKING VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM/I_DRM} AT 130 °C MAXIMUM mA
VSK.170- VSK.250-	04	400	500	50
	08	800	900	
	10	1000	1100	
	12	1200	1300	
	14	1400	1500	
	16	1600	1700	

VSK.170PbF, .250PbF Series



Vishay High Power Products

SCR/SCR and SCR/Diode
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ON-STATE CONDUCTION

PARAMETER	SYMBOL	TEST CONDITIONS			VSK.170	VSK.250	UNITS			
Maximum average on-state current at case temperature	I _{T(AV)}	180° conduction, half sine wave			170	250	A			
					85	85	°C			
Maximum RMS on-state current	I _{T(RMS)}	As AC switch			377	555				
Maximum peak, one-cycle on-state non-repetitive, surge current	I _{TSM}	t = 10 ms	No voltage reapplied	Sinusoidal half wave, initial T _J = T _J maximum	5100	8500	A			
		t = 8.3 ms			5350	8900				
		t = 10 ms	100 % V _{RRM} reapplied		4300	7150				
		t = 8.3 ms			4500	7500				
Maximum I ² t for fusing	I ² t	t = 10 ms	No voltage reapplied		131	361	kA ² s			
		t = 8.3 ms			119	330				
		t = 10 ms	100 % V _{RRM} reapplied		92.5	255				
		t = 8.3 ms			84.4	233				
Maximum I ² √t for fusing	I ² √t	t = 0.1 to 10 ms, no voltage reapplied			1310	3610	kA ² √s			
Low level value or threshold voltage	V _{T(TO)1}	(16.7 % x π x I _{T(AV)} < I < π x I _{T(AV)}), T _J = T _J maximum			0.89	0.97	V			
High level value of threshold voltage	V _{T(TO)2}	(I > π x I _{T(AV)} < I < π x I _{T(AV)}), T _J = T _J maximum			1.12	1.00				
Low level value on-state slope resistance	r _{t1}	(16.7 % x π x I _{T(AV)} < I < π x I _{T(AV)}), T _J = T _J maximum			1.34	0.60	mΩ			
High level value on-state slope resistance	r _{t2}	(I > π x I _{T(AV)} < I < π x I _{T(AV)}), T _J = T _J maximum			0.96	0.57				
Maximum on-state voltage drop	V _{TM}	I _{TM} = π x I _{T(AV)} , T _J = T _J maximum, 180° conduction, average power = V _{T(TO)} x I _{T(AV)} + r _t x (I _{T(RMS)}) ²			1.60	1.44	V			
Maximum holding current	I _H	Anode supply = 12 V, initial I _T = 30 A, T _J = 25 °C			500	500	mA			
Maximum latching current	I _L	Anode supply = 12 V, resistive load = 1 Ω, gate pulse: 10 V, 100 μs, T _J = 25 °C			1000	1000				

SWITCHING

PARAMETER	SYMBOL	TEST CONDITIONS			VSK.170	VSK.250	UNITS
Typical delay time	t _d	T _J = 25 °C, gate current = 1 A dI _g /dt = 1 A/μs V _d = 0.67 % V _{DRM}			1.0		μs
Typical rise time	t _r				2.0		
Typical turn-off time	t _q				50 - 150		

BLOCKING

PARAMETER	SYMBOL	TEST CONDITIONS			VSK.170	VSK.250	UNITS
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	T _J = T _J maximum			50		mA
RMS insulation voltage	V _{INS}	50 Hz, circuit to base, all terminals shorted, 25 °C, 1 s			3000		V
Critical rate of rise of off-state voltage	dV/dt	T _J = T _J maximum, exponential to 67 % rated V _{DRM}			1000		V/μs



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TRIGGERING

PARAMETER	SYMBOL	TEST CONDITIONS		VSK.170	VSK.250	UNITS	
Maximum peak gate power	P _{GM}	t _p ≤ 5 ms, T _J = T _J maximum		10.0		W	
Maximum average gate power	P _{G(AV)}	f = 50 Hz, T _J = T _J maximum		2.0			
Maximum peak gate current	+ I _{GM}	t _p ≤ 5 ms, T _J = T _J maximum		3.0		A	
Maximum peak negative gate voltage	- V _{GT}	t _p ≤ 5 ms, T _J = T _J maximum		5.0		V	
Maximum required DC gate voltage to trigger	V _{GT}	T _J = - 40 °C	Anode supply = 12 V, resistive load; Ra = 1 Ω	4.0			
		T _J = 25 °C		3.0			
		T _J = T _J maximum		2.0			
Maximum required DC gate current to trigger	I _{GT}	T _J = - 40 °C	Anode supply = 12 V, resistive load; Ra = 1 Ω	350		mA	
		T _J = 25 °C		200			
		T _J = T _J maximum		100			
Maximum gate voltage that will not trigger	V _{GD}	T _J = T _J maximum, rated V _{DRM} applied		0.25		V	
Maximum gate current that will not trigger	I _{GD}	T _J = T _J maximum, rated V _{DRM} applied		10.0		mA	
Maximum rate of rise of turned-on current	dI/dt	T _J = T _J maximum, I _{TM} = 400 A, rated V _{DRM} applied		500		A/μs	

THERMAL AND MECHANICAL SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS		VSK.170	VSK.250	UNITS
Junction operating temperature range	T _J	-		- 40 to 130		°C
Storage temperature range	T _{Stg}			- 40 to 150		
Maximum thermal resistance, junction to case per junction	R _{thJC}	DC operation		0.17	0.125	K/W
Typical thermal resistance, case to heatsink per module	R _{thCS}			0.02	0.02	
Mounting torque ± 10 %	MAP to heatsink busbar to MAP	A mounting compound is recommended and the torque should be rechecked after a period of about 3 hours to allow for the spread of the compound.		4 to 6		Nm
Approximate weight				500	g	
Case style				17.8	oz.	

ΔR CONDUCTION PER JUNCTION

DEVICES	SINUSOIDAL CONDUCTION AT T _J MAXIMUM					RECTANGULAR CONDUCTION AT T _J MAXIMUM					UNITS
	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	
VSK.170-	0.009	0.010	0.010	0.020	0.032	0.007	0.011	0.015	0.020	0.033	K/W
VSK.250-	0.009	0.010	0.014	0.020	0.032	0.007	0.011	0.015	0.020	0.033	

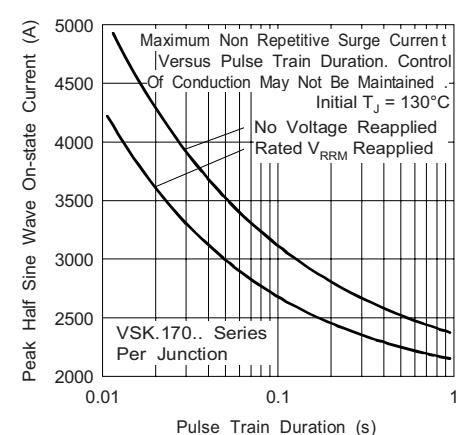
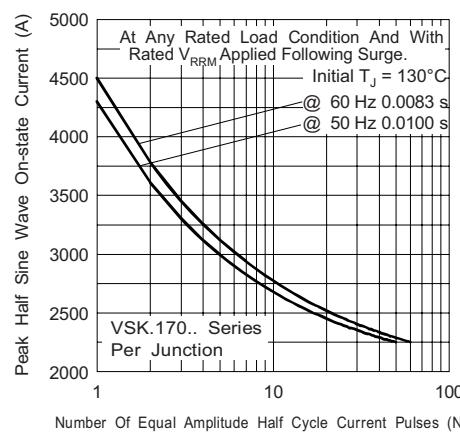
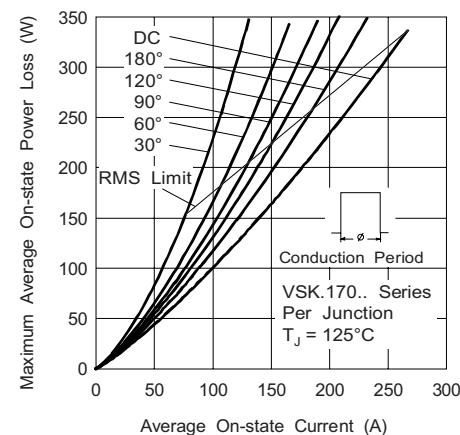
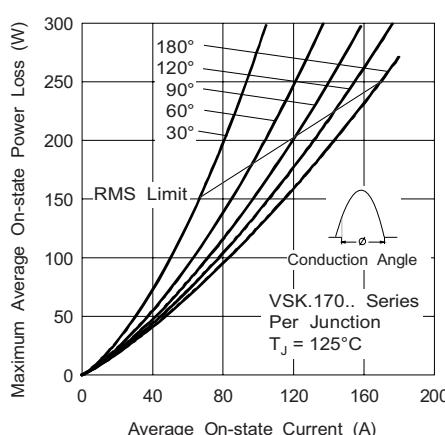
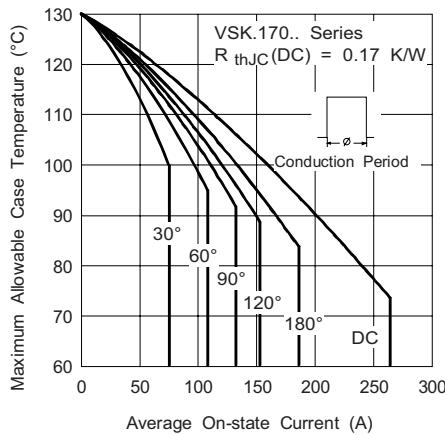
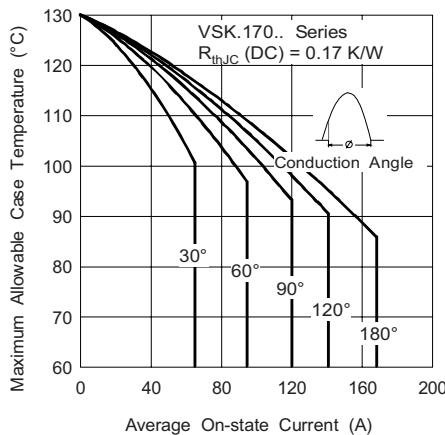
Note

- Table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

VSK.170PbF, .250PbF Series

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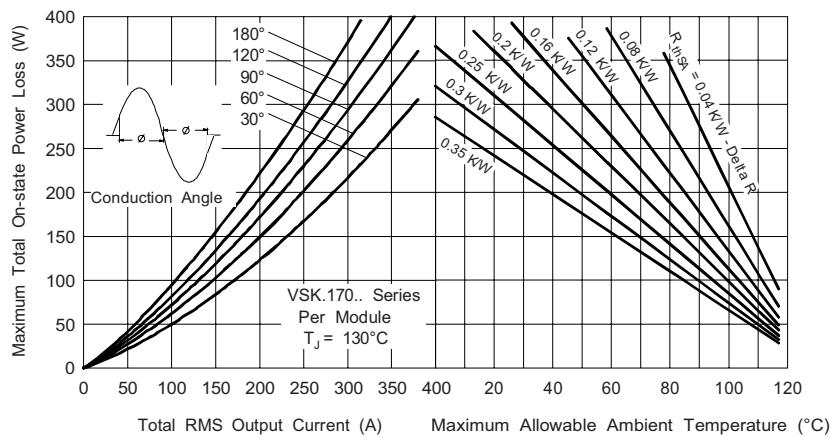


Fig. 7 - On-State Power Loss Characteristics

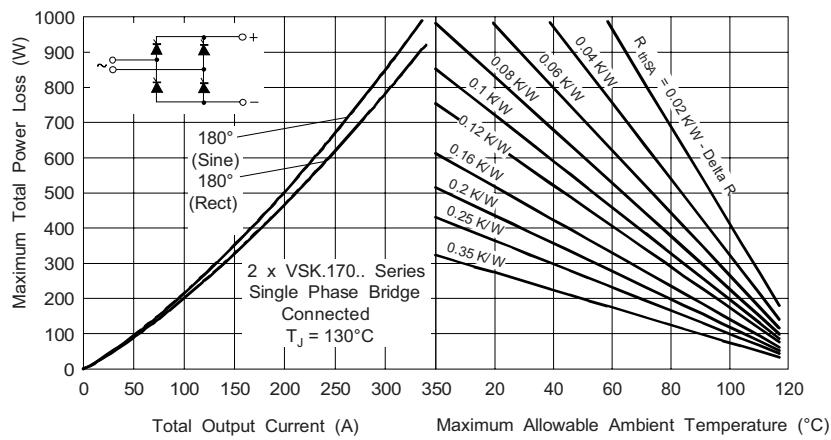


Fig. 8 - On-State Power Loss Characteristics

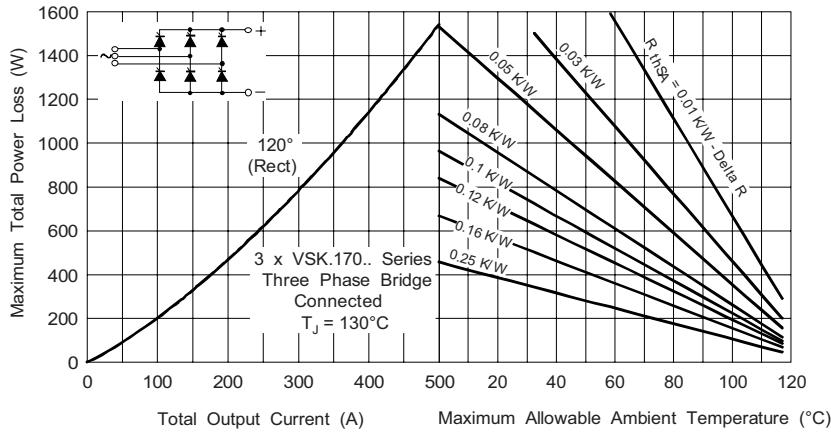


Fig. 9 - On-State Power Loss Characteristics

VSK.170PbF, .250PbF Series

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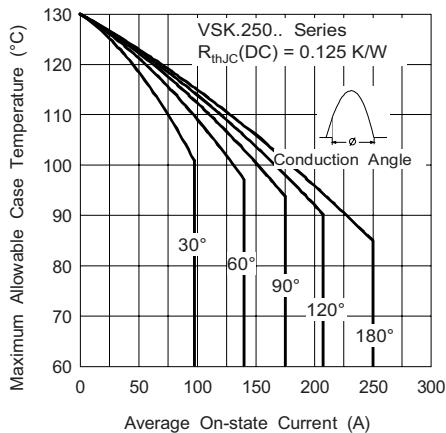


Fig. 10 - Current Ratings Characteristics

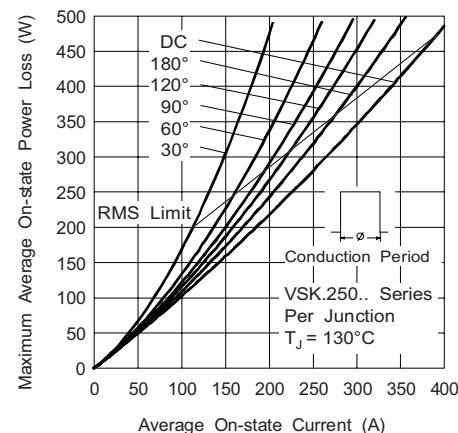


Fig. 13 - On-State Power Loss Characteristics

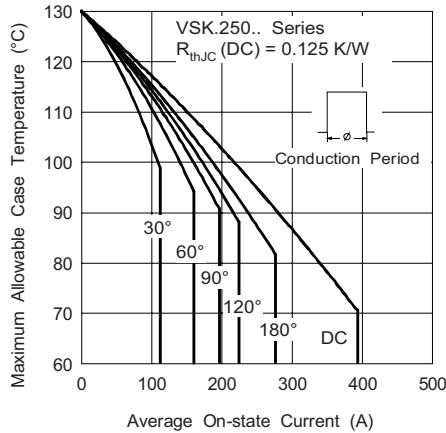


Fig. 11 - Current Ratings Characteristics

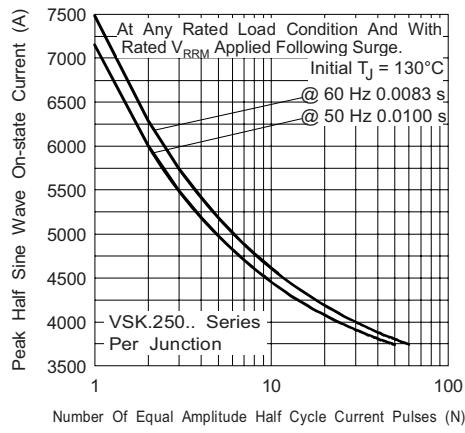


Fig. 14 - Maximum Non-Repetitive Surge Current

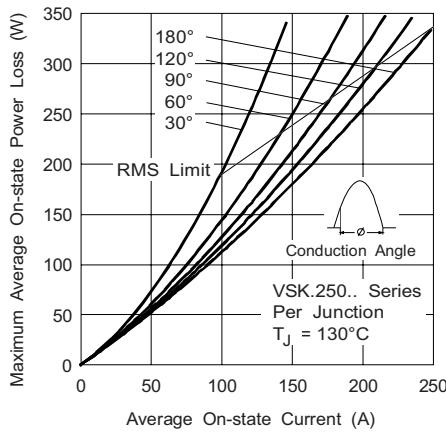


Fig. 12 - On-State Power Loss Characteristics

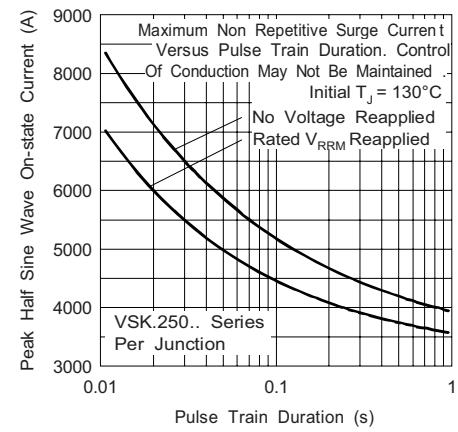


Fig. 15 - Maximum Non-Repetitive Surge Current

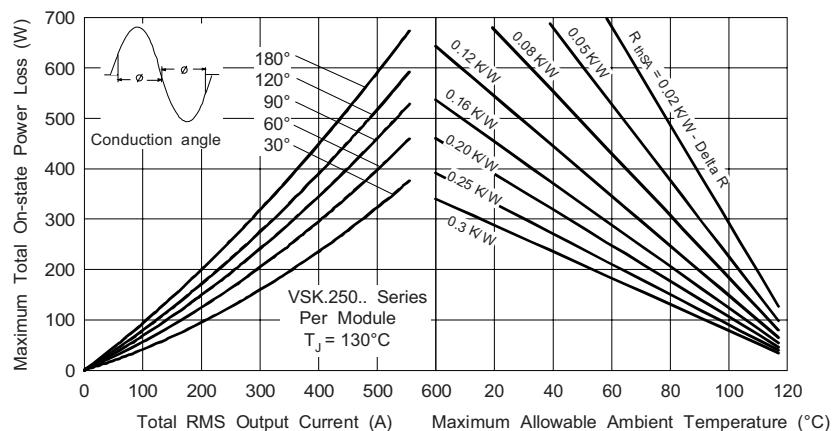


Fig. 16 - On-State Power Loss Characteristics

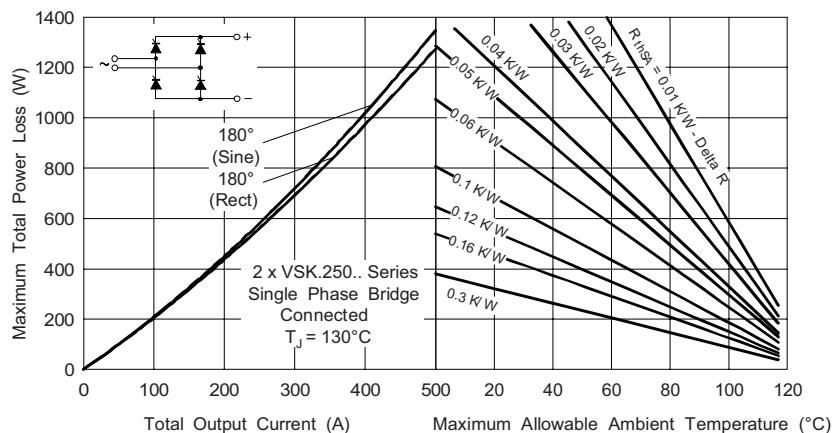


Fig. 17 - On-State Power Loss Characteristics

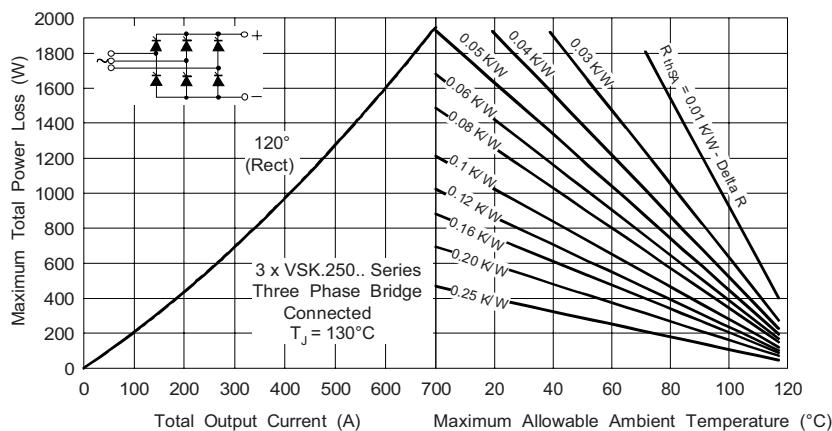


Fig. 18 - On-State Power Loss Characteristics

VSK.170PbF, .250PbF Series

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(MAGN-A-PAK™ Power Modules), 170/250 A

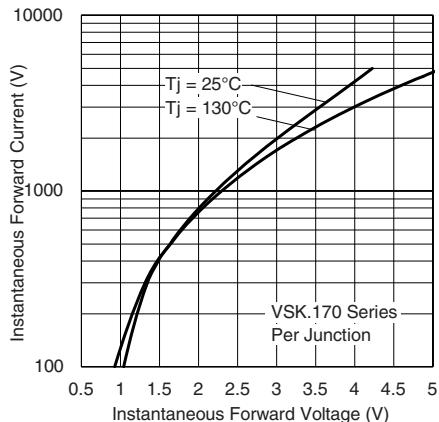


Fig. 19 - On-State Voltage Drop Characteristics

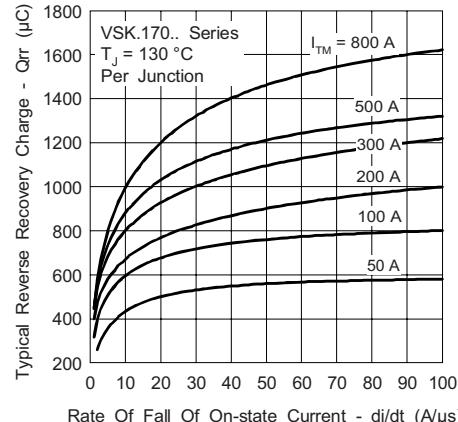


Fig. 21 - Reverse Recovery Charge Characteristics

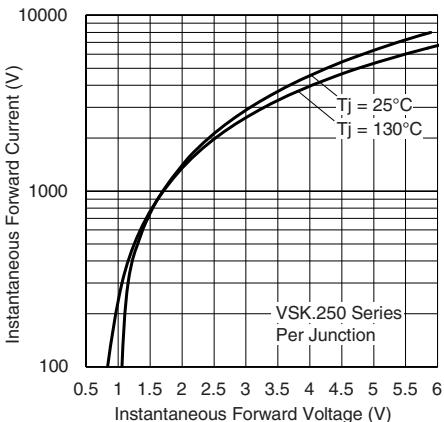


Fig. 20 - On-State Voltage Drop Characteristics

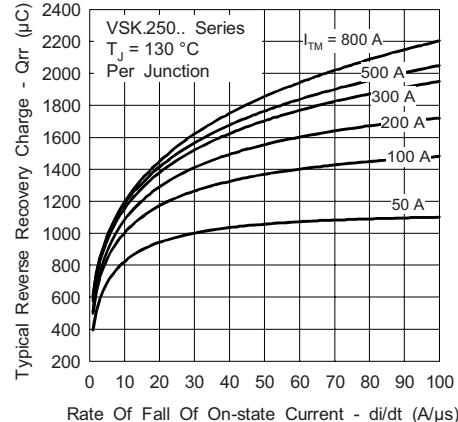


Fig. 22 - Reverse Recovery Charge Characteristics

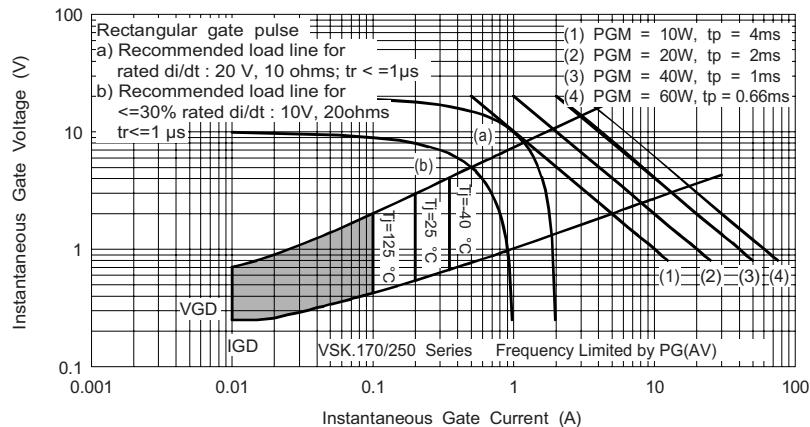
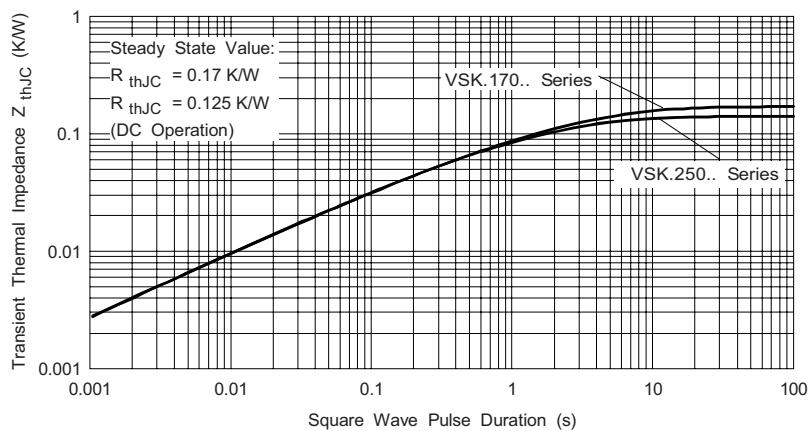


Fig. 23 - Gate Characteristics


Fig. 24 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE

Device code	VSK	T	250	-	16	PbF
	(1)	(2)	(3)	(4)	(5)	
[1]	-	Module type				
[2]	-	Circuit configuration (see dimensions - link at the end of datasheet)				
[3]	-	Current rating				
[4]	-	Voltage code x 100 = V_{RRM} (see Voltage Ratings table)				
[5]	-	Lead (Pb)-free				

Note

- To order the optional hardware go to www.vishay.com/doc?95172

VSK.170PbF, .250PbF Series

Vishay High Power Products

SCR/SCR and SCR/Diode
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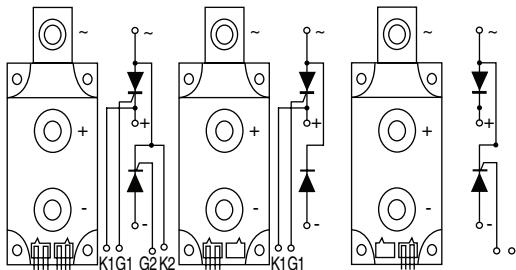


CIRCUIT CONFIGURATION

VSKT...

VSKH...

VSKL...



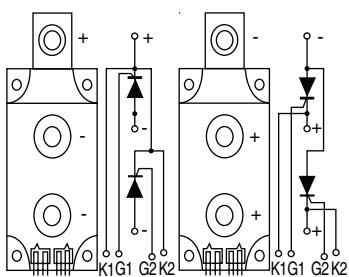
Available from 400 V to 1600 V

VSKU...

VSKV...

VSKK...

Available on 1600 V
Contact factory for
different requirement



LINKS TO RELATED DOCUMENTS

Dimensions

<http://www.vishay.com/doc?95086>



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